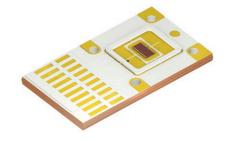
# **OSRAM** LE A P1MR **Datasheet**



## OSRAM OSTAR® Projection Power

## LE A P1MR

OSRAM OSTAR Projection Power is a high luminance LED for projection applications.





#### **Applications**

- Projection & Display

- Visualization

#### **Features**

- Package: OSTAR High Power Projection

- Chip technology: Thinfilm

- Typ. Radiation: 120° (Lambertian emitter)

- Color: λ<sub>dom</sub> = 614 nm (• amber)

- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

## **Ordering Information**

Luminous Flux 1) Type Ordering Code  $I_{\rm c}$  = 8000 mA

LE A P1MR-SSTQ-2 2240 ... 3300 lm Q65113A2122



Maximum Ratings			
Parameter	Symbol		Values
Storage Temperature	$T_{stg}$	min. max.	-40 °C 85 °C
Junction Temperature	T <sub>j</sub>	max.	125 °C
Forward Current $T_{j} = T_{j,max}$	I <sub>F</sub>	min. max.	200 mA 11000 mA
Forward Current pulsed D = 0.6; f = 240 Hz; T <sub>i</sub> = T <sub>i,max</sub>	 F pulse		11000 mA
Surge Current $t_p \le 50 \ \mu s; \ D = 0.1; \ T_j = T_{j,max}$	I <sub>FS</sub>	max.	13700 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	$V_{\scriptscriptstyle{ESD}}$		2 kV
Reverse current 2)	I <sub>R</sub>	max.	200 mA
Max. voltage difference anode-board, cathode-board	$ \Delta V_{a-b} ,  \Delta V_{c-b} $	max.	40 V



## Characteristics

 $T_{Board} = 25 \, ^{\circ}C; \, I_{F} = 8000 \, \text{mA}; \, f = 1000 \, \text{Hz}; \, D = 0.25$ 

Parameter	Symbol		Values
Peak Wavelength	$\lambda_{peak}$	typ.	622 nm
Dominant Wavelength 3)	$\lambda_{\sf dom}$	min.	612 nm
	35	typ.	614 nm
		max.	618 nm
Spectral bandwidth at 50% I <sub>rel,max</sub>	Δλ	typ.	17 nm
Viewing angle at 50% $\rm I_{\rm v}$	2φ	typ.	120 °
Radiating surface	$A_{color}$	typ.	3.35 x 1.55
	0010.		mm²
Partial Flux acc. CIE 127:2007 4)	Φ <sub>E/V, 120°</sub>	typ.	0.77
$I_{\rm F} = 8000 \text{ mA}$			
Forward Voltage 5)	V <sub>F</sub>	min.	5.2 V
$I_{\rm F} = 8000 \text{ mA}$	•	typ.	5.8 V
		max.	6.6 V
Reverse voltage (ESD device)	$V_{RESD}$	min.	45 V
Reverse voltage 2)	$V_{R}$	max.	1.2 V
I <sub>R</sub> = 20 mA			
Real thermal resistance junction/board	$R_{thJB\ real}$	typ.	0.90 K / W
Electrical thermal resistance junction/board	R <sub>thJB elec.</sub>	typ.	0.70 K / W
with efficiency $\eta_e$ = 22 %			



## **Brightness Groups**

Group	Luminous Flux $^{1)}$ $I_F = 8000 \text{ mA}$	Luminous Flux 1) I <sub>F</sub> = 8000 mA	
	min.	max.	
	$\Phi_{v}$	$\Phi_{V}$	
SS	2240 lm	2400 lm	
ST	2400 lm	2590 lm	
SU	2590 lm	2800 lm	
TP	2800 lm	3040 lm	
TQ	3040 lm	3300 lm	

## Wavelength Groups

Group	Dominant Wavelength 3)	Dominant Wavelength 3)	
	min.	max.	
	$\lambda_{\sf dom}$	$\lambda_{dom}$	
2	612 nm	618 nm	

## **Group Name on Label**

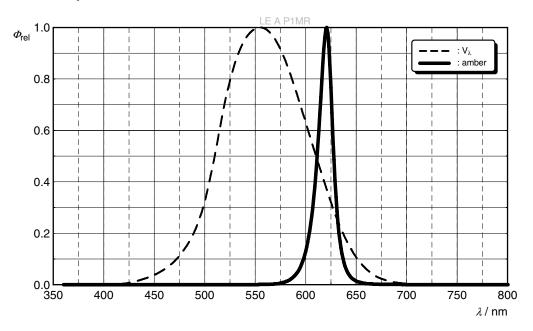
Example: SS-2

Brightness	Wavelength
SS	2



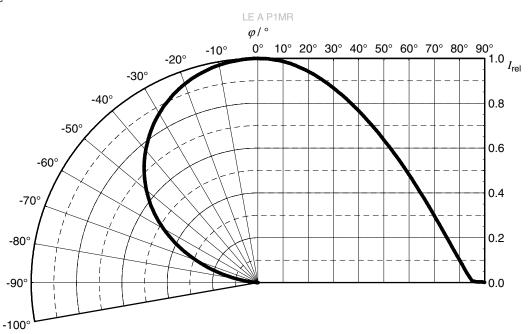
#### Relative Spectral Emission 4)

 $\Phi_{rel}$  = f ( $\lambda$ ); I<sub>F</sub> = 8000 mA; T<sub>J</sub> = 25 °C



#### Radiation Characteristics 4)

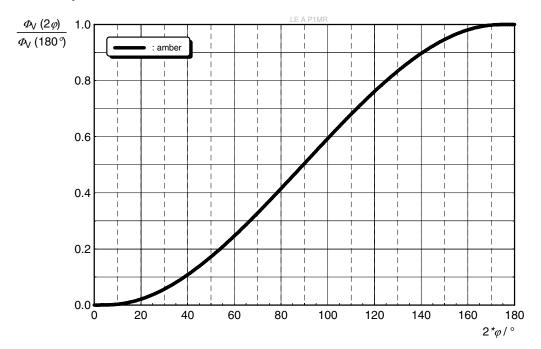
 $I_{rel} = f (\phi); T_J = 25 °C$ 





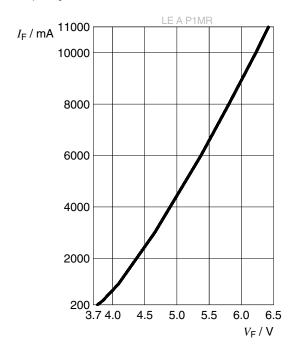
#### Relative Partial Flux 4)

 $\Phi_{_{V}}(2\phi)/\Phi_{_{V}}(180^{\circ}) = f(\phi); T_{_{J}} = 25 \,^{\circ}C$ 



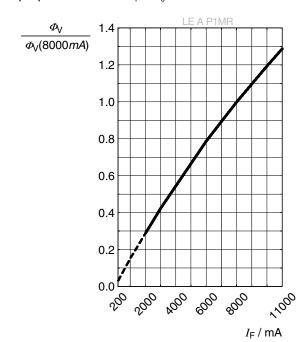
#### Forward current 4)

$$I_F = f(V_F); T_J = 25 \, ^{\circ}C$$



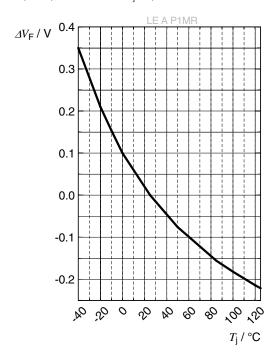
#### Relative Luminous Flux 4), 6)

$$\Phi_{V}/\Phi_{V}(8000 \text{ mA}) = f(I_{F}); T_{J} = 25 \text{ }^{\circ}\text{C}$$



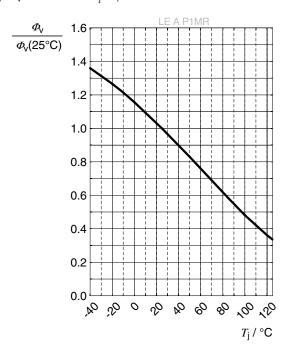
#### Forward Voltage 4)

$$\Delta V_F = V_F - V_F (25 \ ^{\circ}C) = f(T_i); I_F = 8000 \ mA$$



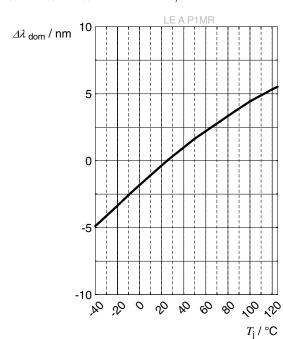
#### Relative Luminous Flux 4)

$$\Phi_{v}/\Phi_{v}(25 \text{ °C}) = f(T_{i}); I_{F} = 8000 \text{ mA}$$



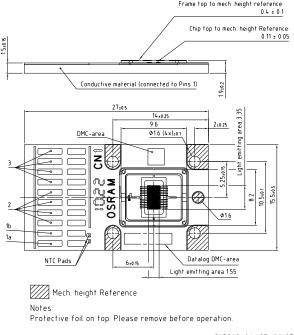
## Dominant Wavelength 4)

$$\Delta\lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}} (25 \text{ °C}) = f(T_j); I_F = 8000 \text{ mA}$$





#### Dimensional Drawing 7)



C63062-A4423-A1-05

#### **Further Information:**

**Approximate Weight:** 5,000.0 mg

**ESD** advice: The device is protected by ESD device which is connected in parallel to the

Chip.

Notes: For superior solder joint connectivity results we recommend soldering under

standard nitrogen atmosphere.

Package not suitable for any kind of wet cleaning or ultrasonic cleaning.

TYU, TU1502 Series, 1.50mm Pitch, Wire to Board Wafer, Connector:

Part Number TU1502WNR-10S-\*-\*

Recommended mating

TYU, TU1502 Series, 1.50mm Pitch, Wire to Board Housing,

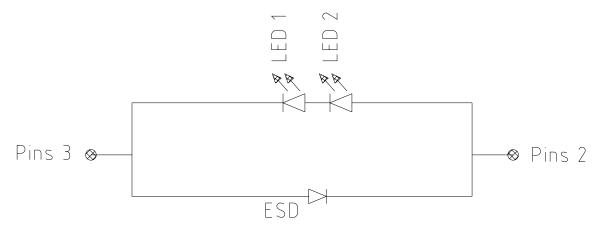
connector: Part Number TU1502HNO-10

TYU, TU1502 Series, 1.50mm Pitch, Terminal,

Part Number TU1502TPO-\*



#### **Electrical Internal Circuit**



Pins 1a: NTC/Substrate potential, isolated from Cathode and Anode

Pins 1b: NTC

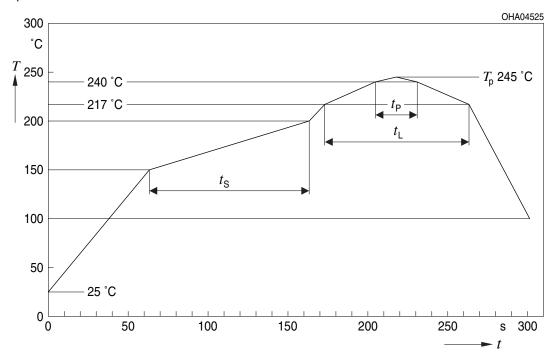
Pins 2: Anode

Pins 3: Cathode



#### **Reflow Soldering Profile**

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



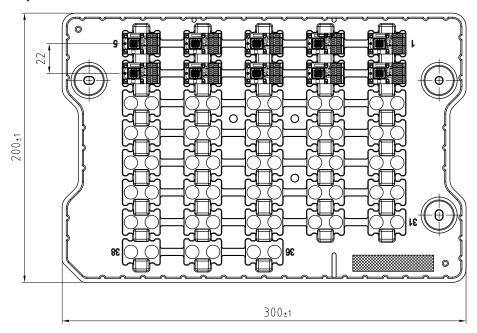
K/s
S
K/s
°C
S
°C
S
K/s
S

All temperatures refer to the center of the package, measured on the top of the component

<sup>\*</sup> slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



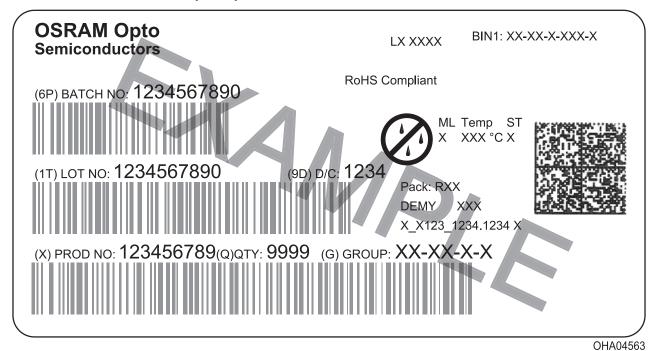
Tray 7) 38 pieces per tray



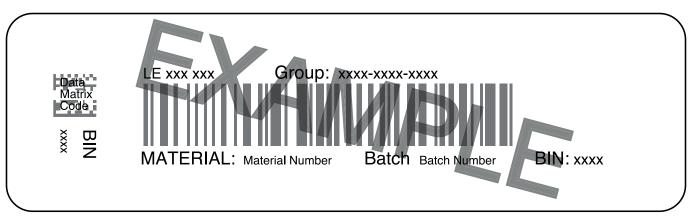
C63062-A4389-B10-01



#### **Barcode-Product-Label (BPL)**



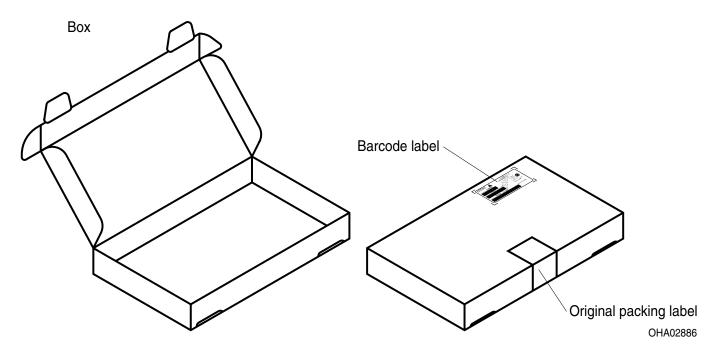
## Barcode-Tray-Label (BTL)



OHA02684\_1



## Schematic Transportation Box 7)



## **Dimensions of Transportation Box**

Width	Length	Height	
333 ± 5 mm	218 ±5 mm	28 ± 5 mm	
337 ± 5 mm	218 ±5 mm	63 ± 5 mm	



## **Data Matrix Code Description**

The Data Matrix Code bin information is Laser marked during testing

Content: aaaa@bbbb@ccc@ddddd@eeeee

Data Matrix Code Type: ECC200

a = Luminous Flux (Phiv) [lm] or Radiant Flux (Phie) [W]	(example: 3306)
b = Forward Voltage (Vf) [V]	(example: 3.46)
c = Wavelength (Ldom) [nm]	(example: 618)
d = Color Coordinate Cx	(example: 0.321)
e = Color Coordinate Cy	(example: 0.641)

@: Seperator = Blank

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#### **Notes**

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class exempt group (exposure time 10000 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes



#### Disclaimer

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

#### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

#### Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



#### Glossary

- Brightness: Brightness values are measured during a pulse train of 100 ms with a pulse width of 250 us and a frequencey of 1 kHz, with an internal reproducibility of +/- 8 % and an expanded uncertainty of +/- 11 % (acc. to GUM with a coverage factor of k = 3). The peak brightness is calculated according to the pulse duration and frequency.
- Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Wavelength: The wavelength is measured during a pulse train of 100 ms with a pulse width of 250 µs and a frequencey of 1 kHz, with an internal reproducibility of ± 0,5 nm and an expanded uncertainty of ± 1 nm (acc. to GUM with a coverage factor of k=3).
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Forward Voltage: The forward voltage is measured during a pulse of typical 250 µs, with an internal reproducibility of +/- 0,05 V and an expanded uncertainty of +/- 0,1 V (acc. to GUM with a coverage factor of k=3).
- 6) Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.

LE A P1MR DATASHEET



## **Revision History**

Version	Date	Change
1.0	2021-05-31	Initial Version
1.1	2022-08-17	Dimensional Drawing



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